## 2SK2590

## Silicon N-Channel MOS FET

# **HITACHI**

**Preliminary** 

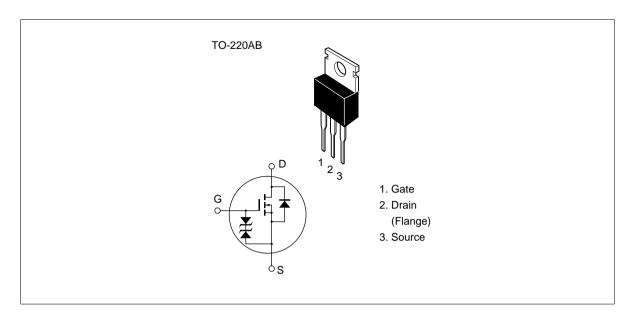
### **Application**

High speed power switching

#### **Features**

- Low on-resistance
- High speed switching
- Low drive current
- No Secondary Breakdown
- Suitable for Switching regulator, DC-DC converter, Motor Control

#### Outline





## 2SK2590

## **Absolute Maximum Ratings** ( $Ta = 25^{\circ}C$ )

Item	Symbol	Ratings	Unit
Drain to source voltage	$V_{\scriptscriptstyle DSS}$	200	V
Gate to source voltage	$V_{GSS}$	±20	V
Drain current	I <sub>D</sub>	7	A
Drain peak current	l <sub>D(pulse)</sub> *1	28	A
Body to drain diode reverse drain current	I <sub>DR</sub>	7	A
Channel dissipation	Pch*2	50	W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

Notes 1. PW  $\leq$  10  $\mu$ s, duty cycle  $\leq$  1 %

<sup>2.</sup> Value at Tc = 25 °C

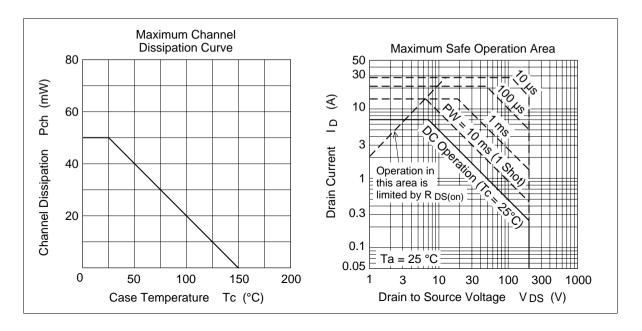
## **Electrical Characteristics** ( $Ta = 25^{\circ}C$ )

Item	Symbol	Min	Тур	Max	Unit	Test Conditions
Drain to source breakdown voltage	$V_{(BR)DSS}$	200	_	_	V	$I_D = 10 \text{ mA}, V_{GS} = 0$
Gate to source breakdown voltage	$V_{(BR)GSS}$	±20	_	_	V	$I_G = \pm 100 \ \mu A, \ V_{DS} = 0$
Gate to source leak current	I <sub>GSS</sub>	_	_	±10	μΑ	$V_{GS} = \pm 16 \text{ V}, V_{DS} = 0$
Zero gate voltage drain current	I <sub>DSS</sub>	_	_	250	μΑ	V <sub>DS</sub> =160 V, V <sub>GS</sub> = 0
Gate to source cutoff voltage	$V_{\rm GS(off)}$	2.0	_	4.0	V	$I_{D} = 1 \text{ mA}, V_{DS} = 10 \text{ V}$
Static drain to source on state resistance	$R_{\scriptscriptstyle DS(on)}$	_	0.33	0.45	Ω	$I_D = 4 A$ $V_{GS} = 10 V^{*1}$
Forward transfer admittance	y <sub>fs</sub>	3.0	4.5	_	S	$I_D = 4 A$ $V_{DS} = 10 V^{*1}$
Input capacitance	Ciss	_	700	_	pF	V <sub>DS</sub> = 10 V
Output capacitance	Coss	_	260	_	pF	$V_{GS} = 0$
Reverse transfer capacitance	Crss	_	45	_	pF	f = 1 MHz
Turn-on delay time	t <sub>d(on)</sub>	_	20	_	ns	I <sub>D</sub> = 4 A
Rise time	t <sub>r</sub>	_	45	_	ns	V <sub>GS</sub> = 10 V
Turn-off delay time	t <sub>d(off)</sub>	_	50	_	ns	$R_L = 7.5\Omega$
Fall time	t <sub>f</sub>	_	35	_	ns	_
Body to drain diode forward voltage	$V_{DF}$	_	1.1	_	V	$I_F = 7 \text{ A}, V_{GS} = 0$
Body to drain diode reverse recovery time	t <sub>rr</sub>	_	150	_	ns	$I_F = 7 \text{ A}, V_{GS} = 0,$ $di_F / dt = 100 \text{ A} / \mu \text{s}$

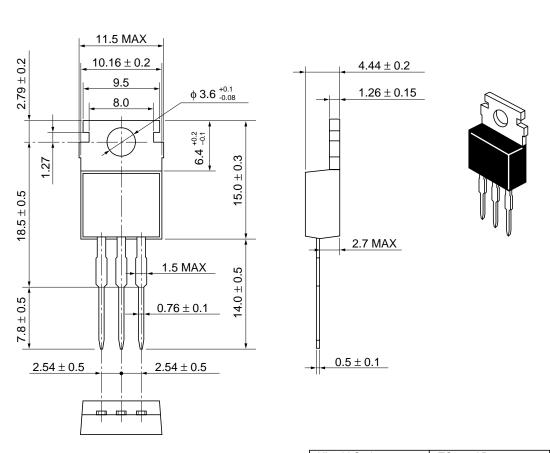
Note 1. Pulse Test

See characteristics curves of 2SK1957.

### 2SK2590



Unit: mm



Hitachi Code	TO-220AB
JEDEC	Conforms
EIAJ	Conforms
Weight (reference value)	1.8 g

#### **Cautions**

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